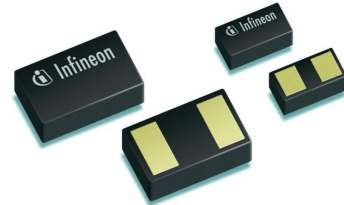


### Bi-directional Low Capacitance TVS Diode

- ESD / transient protection of high-speed data lines in 3.3 / 5 / 12 V applications according to:  
IEC61000-4-2 (ESD):  $\pm 18$  kV (air)  $\pm 15$  kV (contact)  
IEC61000-4-4 (EFT): 40 A (5 / 50 ns)
- Extremely small form factor down to 0.62 x 0.32 x 0.31 mm<sup>3</sup> (0201)
- Max. working voltage: -8 / +14 V
- Very low reverse current < 1 nA typ.
- Very low series inductance down to 0.2 nH typ.
- Low capacitance of 4 pF typ.
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101

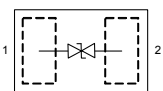


### Applications

- USB 2.0, 10/100 Ethernet, Firewire, DVI
- Mobile communication
- Consumer products (STB, MP3, DVD, DSC...)
- LCD displays, camera
- Notebooks and desktop computers, peripherals



**ESD8V0R1B-02LS**  
**ESD8V0R1B-02LRH**



Type	Package	Configuration	Marking
ESD8V0R1B-02LRH	TSLP-2-17	1 line, bi-directional	E
ESD8V0R1B-02LS	TSSLP-2-1	1 line, bi-directional	E

**Maximum Ratings** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Value	Unit
ESD discharge <sup>1)</sup> air contact	$V_{\text{ESD}}$	18 15	kV
Peak pulse current ( $t_p = 8 / 20 \mu\text{s}$ ) <sup>2)</sup>	$I_{\text{pp}}$	1	A
Operating temperature range	$T_{\text{op}}$	-55...150	°C
Storage temperature	$T_{\text{stg}}$	-65...150	

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**Characteristics**

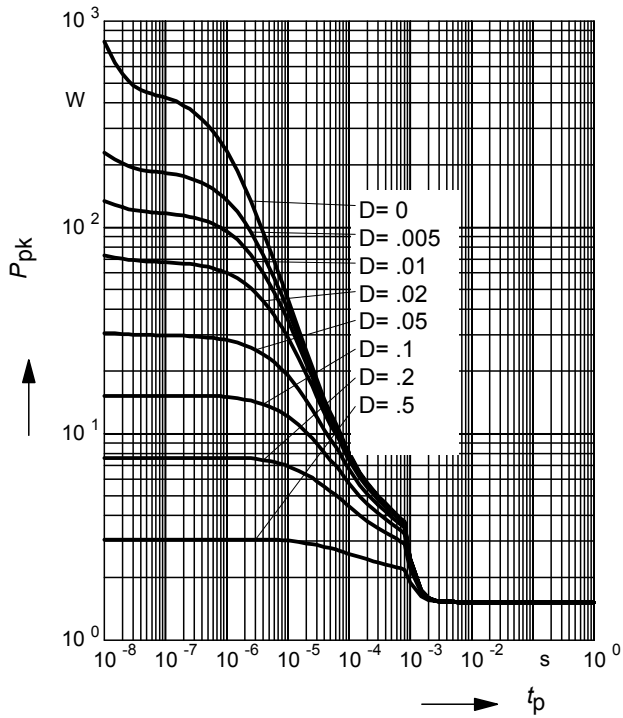
Reverse working voltage, from pin 2 to 1	$V_{\text{RWM}}$	-8	-	14	V
Breakdown voltage	$V_{(\text{BR})}$				
$I_{(\text{BR})} = 1 \text{ mA}$ , from pin 2 to 1 $I_{(\text{BR})} = 1 \text{ mA}$ , from pin 1 to 2		14.5 8.5	17 11	20 14	
Reverse current $V_R = 3.3 \text{ V}$	$I_R$	-	<1	50	nA
Clamping voltage $I_{\text{PP}} = 1 \text{ A}$ , $t_p = 8/20 \mu\text{s}$ , from pin 2 to 1 <sup>2)</sup> $I_{\text{PP}} = 1 \text{ A}$ , $t_p = 8/20 \mu\text{s}$ , from pin1 to 2 <sup>2)</sup>	$V_{\text{CL}}$	- -	23 17	28 22	V
Line capacitance $V_R = 0 \text{ V}$ , $f = 1 \text{ MHz}$	$C_T$	-	4	7	
Series inductance ESD8V0R1B-02LS ESD8V0R1B-02LRH	$L_S$	- -	0.2 0.4	- -	nH

<sup>1)</sup>  $V_{\text{ESD}}$  according to IEC61000-4-2

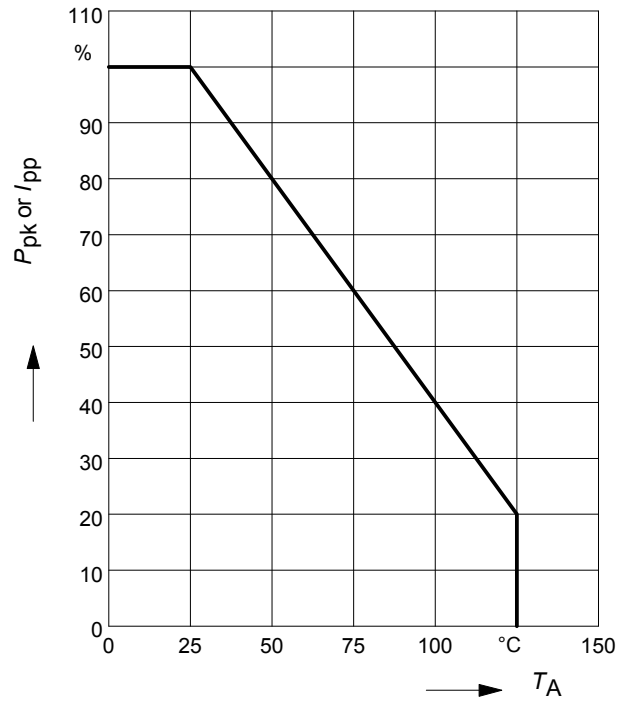
<sup>2)</sup>  $I_{\text{pp}}$  according to IEC61000-4-5

**Non-repetitive peak pulse power**

$P_{pk} = f(t_p)$

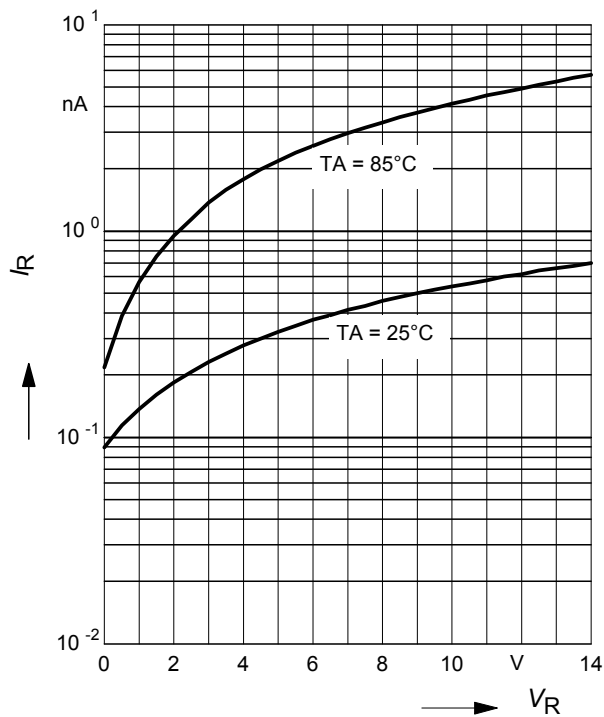


**Power derating curve  $P_{pk} = f(T_A)$**



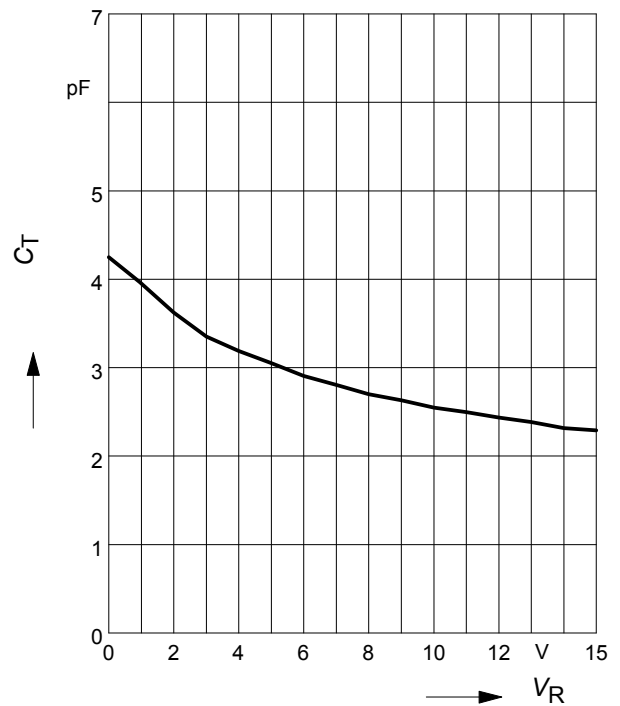
**Reverse current  $I_R = f(V_R)$**

$T_A = \text{Parameter}$



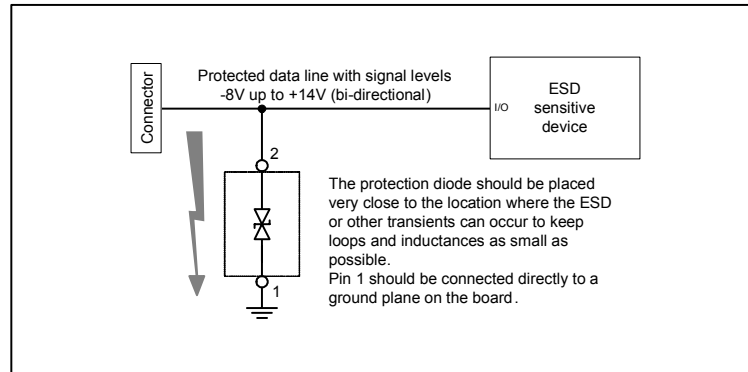
**Diode capacitance  $C_T = f(V_R)$**

$f = 1\text{MHz}$

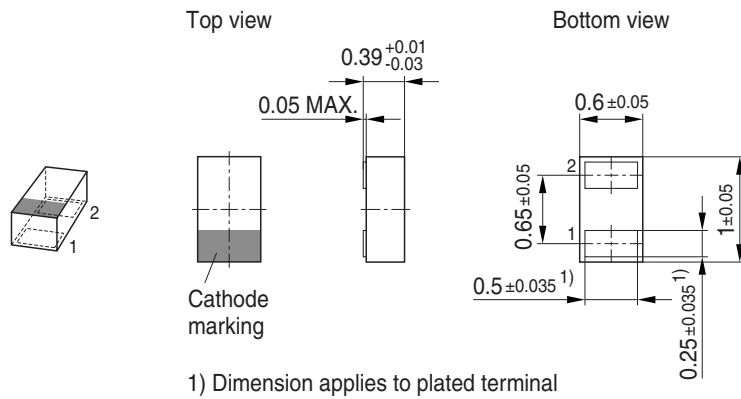


**Application example ESD8V0R1B...**

1 line, bi-directional

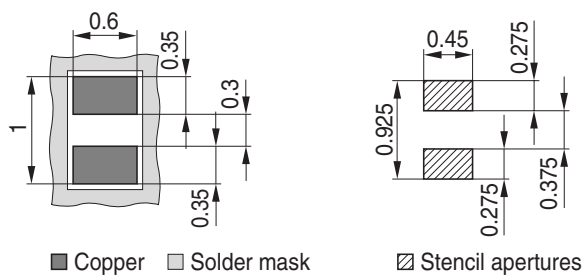


### Package Outline

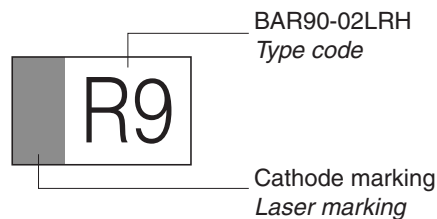


### Foot Print

For board assembly information please refer to Infineon website "Packages"

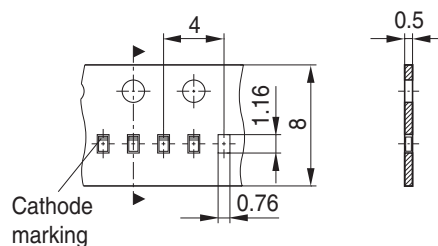


### Marking Layout (Example)

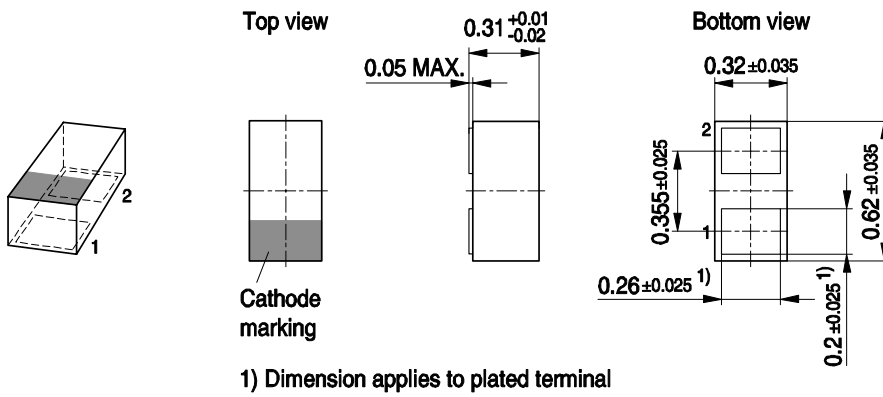


### Standard Packing

Reel ø180 mm = 15.000 Pieces/Reel  
 Reel ø330 mm = 50.000 Pieces/Reel (optional)

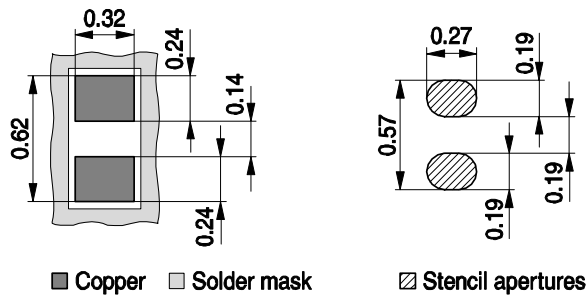


### Package Outline

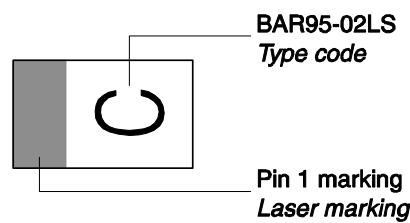


### Foot Print

For board assembly information please refer to Infineon website "Packages"

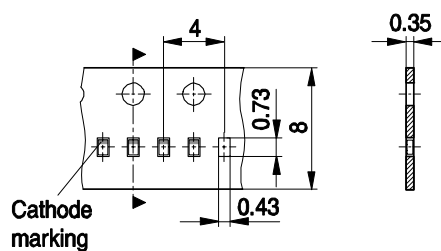


### Marking Layout (Example)



### Standard Packing

Reel  $\varnothing$ 180 mm = 15.000 Pieces/Reel



**Edition 2009-11-16**

**Published by  
Infineon Technologies AG  
81726 Munich, Germany**

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